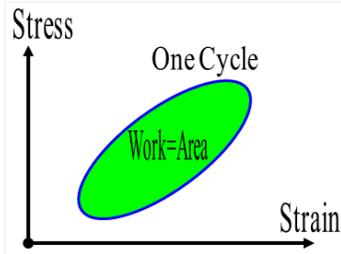


# DfRSoft 2-Day Course

## Shock & Vibration: Test, Design, and Design Assurance

Understanding of vibration and shock stresses is important for the design of reliable products for diverse applications, ranging from consumer portable devices to safety critical equipment operating in extreme environments. The initial sections of the course covers vibration and shock concept, test methods and test equipment in detail. How to use vibration and shock equipment as design aids is also covered. Practical examples are used to illustrate the concepts and the attendees will perform the calculations themselves to help reinforce learning.

Design methods for vibration and shock are covered next part. We start by looking at the typical design maturity stages and how these will relate to different activities for the design process. For the actual design, we look at material selection relative to shock and vibration stress environmental conditions (issues for material modulus, yield strength, hardness, creep requirements, wear issues, fatigue, etc). We then detail isolation and damping design methods to protect against vibration and shock environments. We then look at design margins to assure robustness. A Monte Carlo method is introduced for stack up issues. A key to a successful design program and managing a project is the FMEA tool. We will overview both a top down and bottoms up approach to assure product success.



We then look at design assurance some of which was initially covered with the stage gate approach in design. We discuss reliability and quality analysis so the engineer has an understanding on their importance for design. We then go over some visual inspection methods that help in final product release. The course includes physics of failure and analysis methods so the engineer also has a chance to look at potential historical failure modes in manufactured products, how they occur and what failure analysis tools are needed to help determine root cause issues.

The course targets designers, engineers, test engineers and management. However, different sections vary in engineering level. We provide software to help in test and analysis to make the math easier. Students will be given a trial version of the DfRSoft software (30 day activation) for this course which is not mandatory but helps to accelerate learning. DfRSoft software is a multi-level program with different tools that includes shock and vibration module which greatly helps in teaching this course.

### **Section 1 (168 Slides)**

#### **Understanding Shock & Vibration and its Tests**

##### **Section 1.1 Shock** ..... **3**

- **Overview of Shock & Vibration**
- **What is a G, g, Grms, G-force**
- **Shock**
  - What is shock?
  - Shock testing; electrodynamic (ED), drop shock
  - Shock Equipment; ED, Air Shock, Incline, Drop Shock, Tower Test
  - Common types of shock pulses
  - How does 1G free fall create large G shocks?
  - Physics of drop shock; different pulse shapes, rebound effect
  - Drop height for different masses; PE method
  - Calculating drop height for different pulse shapes
  - Shock Fatigue Testing
  - Shock Response Spectrum (SRS); pyroshock, earthquake, seismic shock
  - Shock & package test references; Mil-STD, ASTM, ISTA

##### **Section 1.2**

- **Sine Vibration** ..... **35**
  - Basics of sine testing using the ED shaker, test fixtures

- Sine wave basics; phase effect, track & dwell, resonance & Q, RMS values
- Sine wave math – amplitude, velocity, acceleration
- Transmissibility, Q, two graphical methods for Q
- Harmonic oscillator physics; natural & forcing frequency, academic & real world Q
- Details of damping, transmissibility Q, resonance
- Sine amplitude equations with Q factor
- Estimates of Q when it cannot be measured for systems & components
- Sweep Rate – Octaves, consequences of too fast a sweep rate
- Dwell sine testing
- Sine Fatigue Life S-N Curves, how the b factor effects the acceleration model
- S-N curves, references
- Accelerated testing using S-N curve information or historic information
- **Constant acceleration** ..... **92**
  - High G level testing, G, RPM

### **Section 1.3**

- **Random vibration testing** ..... **96**
  - Why random
  - Understanding random frequency & time domain
  - Fourier Transform – White Noise
  - Why sine & random are hard to compare
  - ED vs. repetitive shock
  - Calculating Grms from PSD spectrum; hand and complex calculation using DfRSsoft tool, ED displacement, and max likely velocity
  - PSD slope (dB/Octave)
  - Transportation vibration exposure
  - Random vibration accelerated cyclic testing fatigue life estimation
  - Tri-axial fixturing, X, Y, Z data, tri-axial testing
  - Estimating Q from random vibration data
  - Tri-axial and angular testing
  - Accelerometers
  - Sine-on-random
  - Random-on-random
  - Random probability concepts
  - Estimate of peak acceleration/displacement response - Miles equation
  - Exact method for damage estimation (derivation using thermodynamic work)
  - Miner’s approximation – derivation, why it is an approx., stress concentration
- **HALT Random Vibration** ..... **155**
  - ED vs. HALT
  - The HALT Concept

### **Section 2 (49 Slides)**

#### **Complex System Degradation Analysis Methods**

- Parametric Analysis Overview ..... **3**
- System level degradation indications & measurements ..... **20**
  - Thermal degradation
  - Vibration system noise degradation – Variance method
- Parametric Reliability Failure Rate Modeling ..... **33**

### **Section 3 (312 Slides)**

#### **Design Methods for Shock and Vibration**

<b>3.1 Design Stages &amp; The Design Process</b>	<b>3</b>
<ul style="list-style-type: none"> <li>○ Key goals &amp; Filling the Reliability &amp; Quality Gap</li> <li>○ The three fundamental design assurance activities <ul style="list-style-type: none"> <li>○ Design for reliability &amp; quality</li> <li>○ Reliability &amp; quality verification in design</li> <li>○ Analytical physics for design</li> </ul> </li> </ul>	
<b>3.2 The Stage Gate approach for successful design</b>	<b>20</b>
<ul style="list-style-type: none"> <li>○ The design process flow</li> <li>○ Understanding each gate – the tools for your program</li> </ul>	
<b>3.3 Material selection stress considerations in design</b>	<b>57</b>
<ul style="list-style-type: none"> <li>○ Elastic deformation, yielding and ductile rupture material considerations</li> <li>○ Creep &amp; cumulative creep fatigue material considerations</li> <li>○ Excessive wear; friction &amp; lubrication – material selection</li> <li>○ Cyclic fatigue SN curves – material selection</li> <li>○ PCB fatigue life</li> <li>○ Circuit board component fatigue life model analysis –Steinberg Method (sine and random)</li> <li>○ Thermal cycle fatigue</li> <li>○ Engelmaier model - solder component selection &amp; underfill effects on thermal fatigue life</li> <li>○ Four step approach for material selection</li> </ul>	
<b>3.4 Design Margin Methods</b>	<b>165</b>
<ul style="list-style-type: none"> <li>○ Design safety factors</li> <li>○ Reliability Design Safety Margin - load/strength interference</li> <li>○ Electrical derating</li> </ul>	
<b>3.5 Stack Up &amp; Monte Carlo Analysis Methods</b>	<b>192</b>
<ul style="list-style-type: none"> <li>○ Stack up</li> <li>○ Worst case stack up analysis</li> <li>○ Spring rate stack up</li> <li>○ Monte Carlo Methods for stack up</li> <li>○ Monte Carlo Methods for spring rate stack up</li> </ul>	
<b>3.6 Isolation &amp; Damping - Designing for Vibration &amp; Shock Suppression</b>	<b>220</b>
<ul style="list-style-type: none"> <li>○ Vibration Isolation</li> <li>○ Shock Isolation/Absorption</li> <li>○ Packaging guidelines - foam thickness</li> <li>○ Vibration Absorption</li> </ul>	
<b>3.7 Failure Modes Effects Analysis (FMEA), Design Methods</b>	<b>270</b>
<ul style="list-style-type: none"> <li>○ <b>Why FMEA</b></li> <li>○ <b>Team approach</b></li> <li>○ Top-down for DfRQ product program planning</li> <li>○ Bottoms up FMEA</li> <li>○ Design FMEA</li> <li>○ Top down FMEA for program planning</li> </ul>	

**Section 4 (119 Slides)**

**Reliability & Quality Tool Box**

**4.1 Basic Reliability Mathematics**

<b>4</b>	
<ul style="list-style-type: none"> <li>○ MTBF/Time independent failure rate basics</li> <li>○ Reliability conversions</li> <li>○ System reliability analysis</li> <li>○ Block diagrams</li> <li>○ Redundancy K of N</li> </ul>	

○ Reliability allocation	
<b>4.2 Advanced Reliability Mathematics</b>	<b>33</b>
○ Time dependent failure rate	
○ Key reliability functions; CDF, PDF, hazard rate	
○ Reliability Life Data Analysis Methods (Weibull...)	
<b>4.3 Design maturity testing</b>	<b>62</b>
○ DMT Stage Gate	
○ Statistical confidence – Chi-squared confidence	
<b>4.4 Accelerated testing &amp; Models</b>	<b>73</b>
○ Arrhenius temperature model	
○ Temperature-humidity model	
○ Coffin-Manson Thermal Cycle Model	
○ Modified Coffin-Manson Model	
○ Vibration Acceleration Model - Sine or random	
○ General Power Law Model	
○ Accelerated statistical confidence testing	
<b>4.5 Environmental profiling</b>	<b>82</b>
○ CALT like analysis method using DfRSoft methods	
Products that are used at various stress level-how to profile them to one stress level equivalence	
○ Using profiling to target your design and for accelerated testing targeting	
<b>4.6 MTBF Predictions</b>	<b>86</b>
<b>4.7 Quality Aids in Design Assurance</b>	<b>94</b>
○ Basic tools in quality design	
○ Cpk	
○ Normality analysis	
○ Yield	
○ Statistical Process Control (SPC)	
<b>Section 5 (129 Slides)</b>	
<b>Physics of Failure and Failure Analysis</b>	
<b>5.1 Physics of Failure, 7 step problem solving method</b>	<b>2</b>
○ Skills of the Failure Analyst	
○ Failure Analysis reporting – Lessons learned database	
<b>Additional Physic of Failure Modes to those discussed in Sec. 3.3 (covered if time permits)</b>	
<b>5.1 Physics of Failure – Types of Aging, Diffusion, Corrosion, Migration</b>	<b>17</b>
○ Environmental stresses	
○ Three main types of aging	
○ Diffusion	
○ Intermetallics - Gold embrittlement, Kirkendall effect, Purple plague	
○ Corrosion	
○ Ag Migration	
<b>5.2 Physics of Failure – Mechanical Failure, CTE Mismatch, Solder Issues</b>	<b>57</b>
○ Modes of mechanical failure	
○ Stress-strain	
○ CTE Mismatch & thermal fatigue in solder joints	
○ Various failures – related to creep, BGA, Caps...	
<b>5.3 Physics of Failure – Solder Intermetallics, Plating, Contamination, Non Wetting, Coverage</b>	<b>80</b>
○ Solder intermetallics	
○ Plating contamination	
○ Non wetting	
○ Solder coverage	

- Lead Free Issues
- ESD & Electrical Overstress

## Course, Instructor Biography

**Instructor: Alec Feinberg, founder of DfRSoft**



Alec has a Ph.D. in Physics and is the principal author of the book, *Design for Reliability*. He is also the author of the software package DfRSoft, which is used worldwide. Alec has provided reliability engineering services in all areas of reliability and on numerous products in diverse industries for over 35 years that include solar, thin film power electronics, defense, microelectronics, aerospace, wireless electronics, and automotive electrical systems. He has extensive expertise in the area of shock, vibration, and HALT test and analysis methods in working on Military and Commercial products. He has provided training classes in Design for Reliability, Shock and Vibration, HALT, Reliability Growth, Electrostatic Discharge, Dielectric Breakdown, DFMEA and Thermodynamic Reliability Engineering. Alec has presented numerous technical papers and won the 2003 RAMS Alan O. Plait best tutorial award for the topic, “Thermodynamic Reliability Engineering”. He is currently an invited author to contribute on a new book on the Physics of Degradation in Engineering Devices and Materials.

Alec is based in Raleigh, North Carolina.

### Enrollment

Send purchase order to:  
DfRSoft  
9510 Centerwood Dr.  
Raleigh, NC 27617

Email: [support@dfrosoft.com](mailto:support@dfrosoft.com)

Payment Method by purchase order, paypal or credit card)

For further information, please call Dr. Alec Feinberg at 617-943-9034.

### On-Site Company Cost Information (same price as on line for >5 people call or email)

- Two day course - \$950 Per Person (Min. 4 people of \$3800 payment)
- Note 5-10 people, \$850
- No Extra Cost (i.e. DfRSoft pays for its travel expenses)
- Optional - Design for Reliability, Quality, Engineering Software \$395, Free Trial copy included for class